# SKM 800GA125D



# SEMITRANS<sup>TM</sup> 3

## **Ultrafast IGBT Modules**

#### **SKM 800GA125D**

**Target Data** 

#### **Features**

- · Homogeneous Si
- NPT-IGBT
- V<sub>CE(sat)</sub> with positive temperature coefficient
- · High short circuit capability, self limiting to 6 x I<sub>C</sub>

### **Typical Applications**

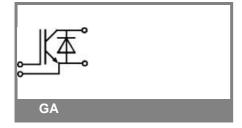
- Resonant inverters up to 100 kHz
- Inductive heating
- Electronic welders at fsw > 20 kHz

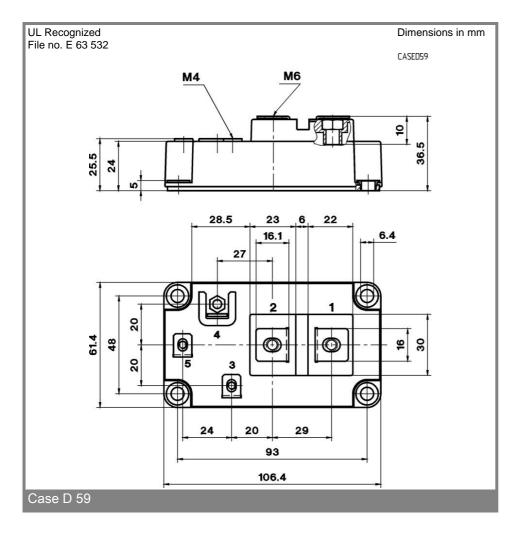
### Remarks

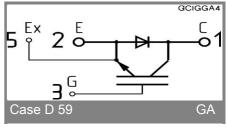
- I<sub>DC</sub> ≤ 500 A limited by terminals
   Take care of over-voltage caused by stray inductances

Absolute Maximum Ratings T <sub>case</sub> = 25°C, unless otherwise specified									
Symbol	Conditions	Values	Units						
IGBT									
$V_{CES}$		1200	V						
I <sub>C</sub>	$T_c = 25 (80)  ^{\circ}C$	760 (530)	Α						
I <sub>CRM</sub>	t <sub>n</sub> = 1 ms	1200	Α						
V <sub>GES</sub>	ľ	± 20	V						
$T_{vj}$ , $(T_{stg})$	$T_{OPERATION} \leq T_{stg}$	- 40 <b>+</b> 150 (125)	°C						
V <sub>isol</sub>	AC, 1 min.	4000	V						
Inverse diode									
I <sub>F</sub>	$T_c = 25 (80)  ^{\circ}C$	720 (500)	Α						
I <sub>FRM</sub>	$t_p = 1 \text{ ms}$	1200	Α						
I <sub>FSM</sub>	$t_p = 10 \text{ ms; sin.; } T_j = 150 ^{\circ}\text{C}$	5000	А						

$ \begin{array}{ c c c c } \textbf{IGBT} \\ \hline V_{GE(th)} & V_{GE} = V_{CE}, \ I_{C} = 24 \ \text{mA} \\ V_{CE(TO)} & V_{GE} = 0, \ V_{CE} = V_{CES}, \ T_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(TO)} & V_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 15 \ V, \ T_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 15 \ V, \ T_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 15 \ V, \ T_{j} = 25 \ (125) \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 25 \ V, \ T_{j} = 125 \ ^{\circ}\text{C} \\ \hline V_{CE(3t)} & V_{j} = 25 \ V, \ T_{j} = 25 \ V, \ T$	<b>Characteristics</b> T <sub>case</sub> = 25°C, unless otherwise specifie							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	Symbol	Conditions	min.	typ.	max.	Units		
$ \begin{array}{ c c c c c c c c c c c c c c c c c c c$	IGBT							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$V_{GE(th)}$	$V_{GE} = V_{CE}$ , $I_C = 24 \text{ mA}$	4,5	5,5	6,5	V		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		$V_{GE} = 0, V_{CE} = V_{CES}, T_{i} = 25 (125) °C$		0,2	0,6	mA		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V <sub>CE(TO)</sub>			, ,	, ,	V		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	-	V <sub>GE</sub> = 15 V, T <sub>j</sub> = 25 (125) °C		2,8 (3,8)	3,3 (5,4)	mΩ		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V <sub>CE(sat)</sub>	$I_{Cnom}$ = 600 A, $V_{GE}$ = 15 V, chip level		3,2 (4)	3,75 (4,55)	V		
$ \begin{array}{c} C_{oes} \\ C_{res} $	C <sub>ies</sub>	1		37		nF		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	C <sub>oes</sub>	$V_{GE} = 0$ , $V_{CE} = 25 V$ , $f = 1 MHz$				nF		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$				2,8				
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	L <sub>CE</sub>				20	nH		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	R <sub>CC'+EE'</sub>	g .		0,18 (0,22)		mΩ		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t <sub>d(on)</sub>					ns		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	t <sub>r</sub>					ns		
$ \begin{array}{ c c c c } \hline E_{on} (E_{off}) & & & & & & & & & & & & \\ \hline \textbf{Inverse diode} \\ \hline V_F = V_{EC} & & & & & & & & & & \\ \hline V_{Foom} = 600 \text{ A; } V_{GE} = 0 \text{ V; } T_j = 25 \text{ (125)} & & & & & & & \\ \hline V_{CTO} & & & & & & & & \\ \hline V_{T} & & & & & & & & \\ \hline V_{T} & & & & & & & \\ \hline V_{T} & & & & & & \\ \hline V_{T} & & & & & & \\ \hline V_{T} & & & & & & \\ \hline V_{T} & & & & \\ \hline V_{T} & & & & & \\ \hline V_{T} & & & \\ \hline V_{T} & & & \\ \hline V_{T} & & & \\ \hline V_{T} & & & & \\ \hline V_{T} & & & & \\ \hline V_{T} & & & $		V <sub>GE</sub> ± 15 V						
$ \begin{array}{ c c c c c } \hline \textbf{Inverse diode} \\ V_F = V_{EC} &   I_{Fnom} = 600 \text{ A; } V_{GE} = 0 \text{ V; } T_j = 25 \text{ (125)} \\ \hline V_{(TO)} & T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Fnom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Fnom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Fnom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{Snom} = 600 \text{ A; } T_j = 25 \text{ (125) °C} \\ \hline I_{RRM} & I_{RRM} & I_{RRM} = 100 \text{ A; } I_{RRM} \\ \hline I_{RRM} & I_{RRM} = 100 \text{ A; } I_{RRM} = 100 \text{ A; } I_{RRM} \\ \hline I_{RRM} & I_{RRM} = 100 \text{ A; } I_{RRM} = 100 $						ns		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	E <sub>on</sub> (E <sub>off</sub> )			52 (26)		mJ		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Inverse diode							
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	$V_F = V_{EC}$	$I_{Fnom} = 600 \text{ A}; V_{GE} = 0 \text{ V}; T_j = 25 (125)$ °C		2,3 (2,1)	2,5 (2,3)	V		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	V <sub>(TO)</sub>	T <sub>j</sub> = 25 (125) °C		1,1 (0,9)	1,3 (1,05)	V		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$				2 (2)	2 (2,1)	mΩ		
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$								
$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$		•				μC		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	E <sub>rr</sub>	V <sub>GE</sub> = 0 V				mJ		
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Thermal characteristics							
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	R <sub>th(j-c)</sub>	per IGBT			0,03	K/W		
Mechanical data         Ms         to heatsink M6         3         5         Nm           Mt         to terminals (M6(M4)         2,5 (1,1)         5 (2)         Nm		per Inverse Diode			0,07	K/W		
$\begin{tabular}{l lllllllllllllllllllllllllllllllllll$	R <sub>th(c-s)</sub>	per module			0,038	K/W		
M <sub>t</sub> to terminals (M6(M4) 2,5 (1,1) 5 (2) Nm								
	$M_s$	to heatsink M6	3		5	Nm		
w 330 g	$M_t$	to terminals (M6(M4)	2,5 (1,1)		5 (2)	Nm		
	w				330	g		







This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

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